

# 6 + 2 Phase Output Controller with SVID Interface for Computer CPU Applications

## NCP81567

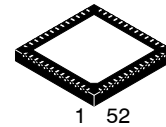
The NCP81567 is a two rail, six plus two–phase buck solution optimized for Intel’s IMVP9.2 CPUs. The multi–phase rail control system is based on Dual–Edge pulse–width modulation (PWM) combined with DCR current sensing. This provides an ultra–fast initial response to dynamic load events and reduced system cost. The NCP81567 has an ultra–low offset current monitor amplifier with programmable offset compensation for high accuracy current monitoring.

### Features

- Vin Range 4.5 V to 21 V
- Startup into Pre–Charged Loads While Avoiding False OVP
- Digital Soft Start Ramp
- Adjustable Vboot
- High Impedance Differential Output Voltage Amplifier
- Dual VID Table Support to be Compatible with IMVP9.2
- Support High Current Extensions
- Dynamic Reference Injection
- Programmable Output Voltage Slew Rates
- Dynamic VID Feed–Forward
- Differential Current Sense Amplifiers for Each Phase
- Programmable Adaptive Voltage Positioning (AVP)
- Adjustable Switching Frequency Range
- Digitally Stabilized Switching Frequency
- UltraSonic Operation
- Supports Acoustic Noise Mitigation Function
- Support for VCCIN\_AUX IMON Input
- PSYS Input Monitor
- Meets Intel’s IMVP9.2 Specifications
- Current Mode Dual Edge Modulation for Fast Initial Response to Transient Loading
- This is a Pb–Free Device

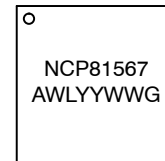
### Typical Applications

- Desktop, Notebook and Ultra–book Computers



1 52  
 QFN52 6x6, 0.4P  
 CASE 485BE

### MARKING DIAGRAM



NCP81567 = Specific Device Code  
 A = Assembly Site  
 WL = Wafer Lot  
 YY = Year  
 WW = Work Week  
 G = Pb–Free Package

### ORDERING INFORMATION

Device	Package	Shipping†
NCP81567MNTXG	QFN52 (Pb–Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

# NCP81567

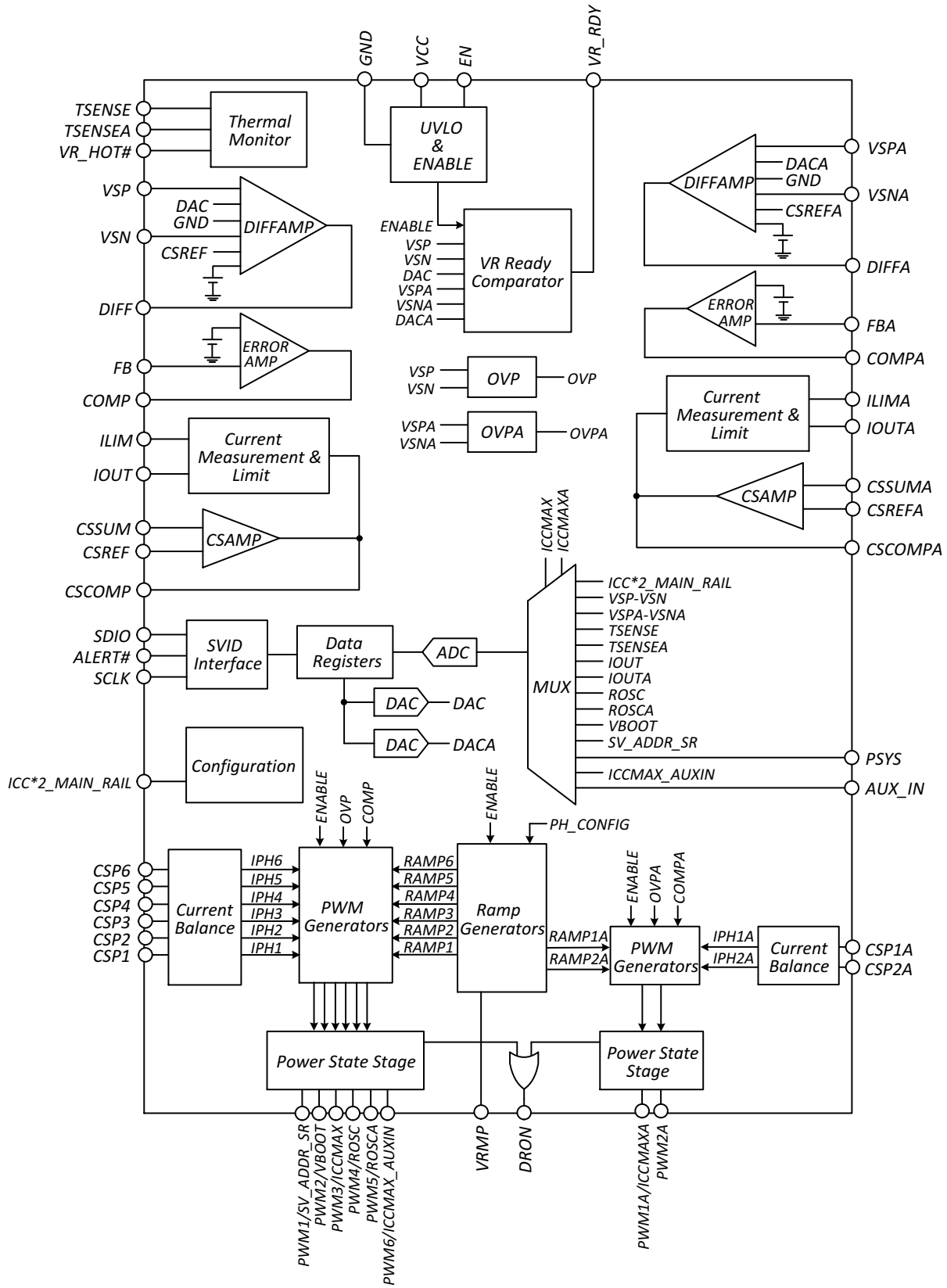


Figure 1. Internal Block Diagram

# NCP81567

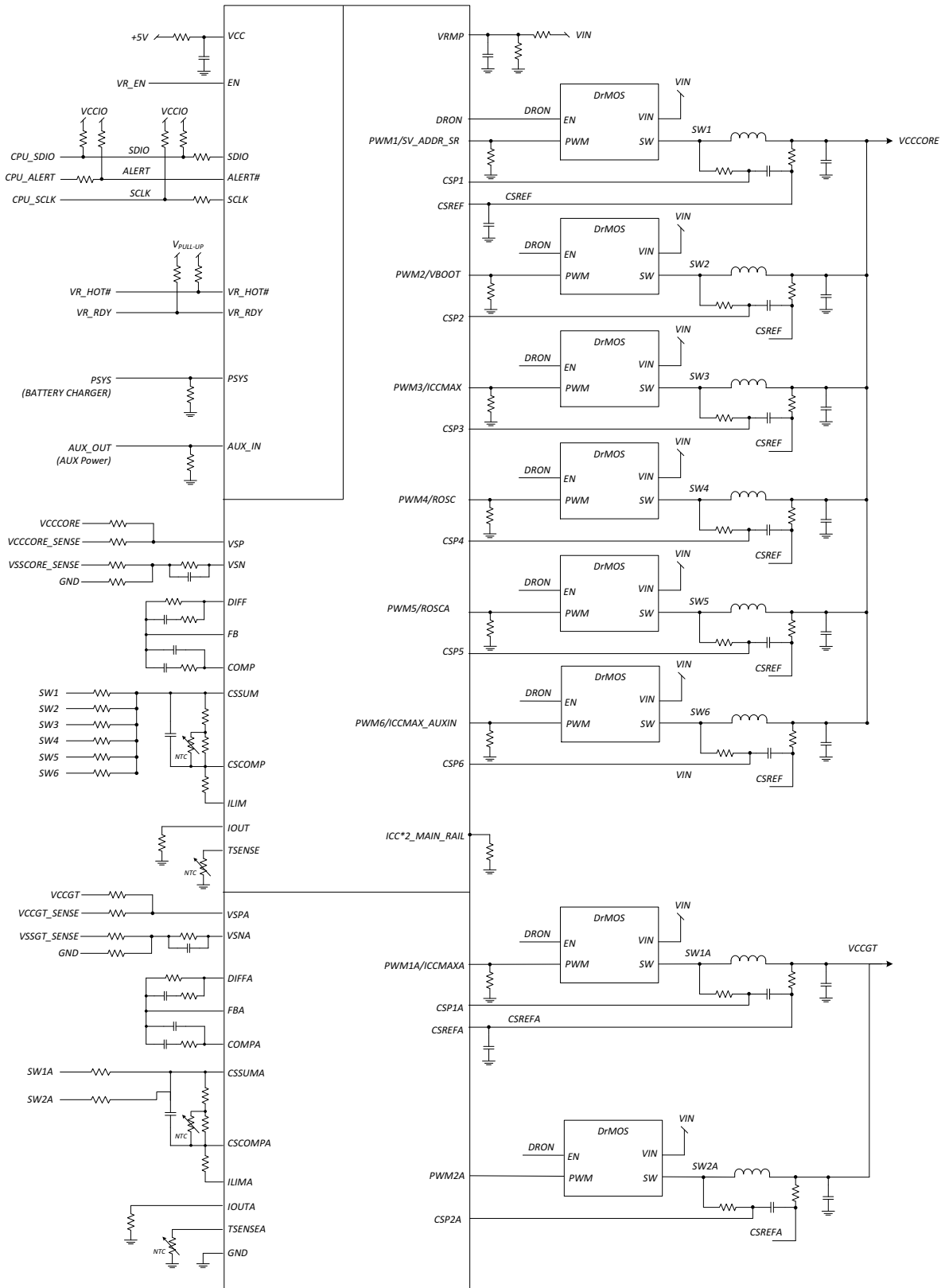
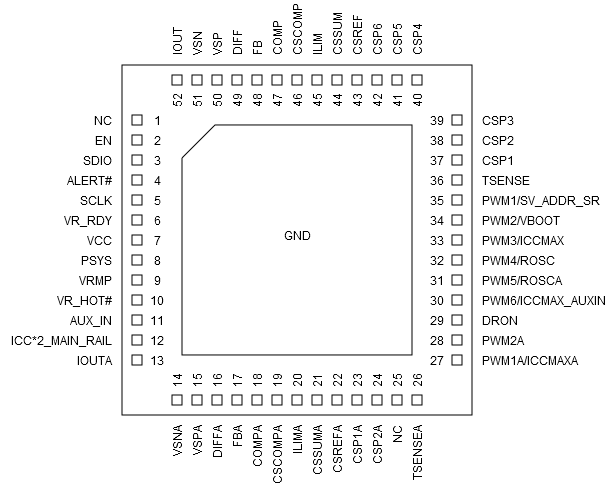


Figure 2. Typical Application Circuit

# NCP81567



**Figure 3. Pinout Diagram (Top View)**

**Table 1. PIN FUNCTION DESCRIPTION**

Pin No.	Pin Name	Description
1	NC	No Connect
2	EN	Enable. High enables both rails
3	SDIO	Serial VID data interface
4	ALERT#	Serial VID ALERT#
5	SCLK	Serial VID clock
6	VR_RDY	VR_RDY indicates both rails are ready to accept SVID commands
7	VCC	Power for the internal control circuits. A decoupling capacitor is connected from this pin to ground
8	PSYS	System power signal input. A resistor to ground scales this signal
9	VRMP	Feed-forward input of Vin for the ramp-slope compensation. The voltage fed into this pin is used to control the ramp of the PWM slopes
10	VR_HOT#	OD output. Indicates high VR temperature
11	AUX_IN	AUX IMON Input
12	ICC*2_MAIN_RAIL	Pulldown on this pin programs ICCMAX on main rail from 255 to 511A
13	IOUTA	Total output current monitor for regulator 2
14	VSNA	Differential output voltage negative sense for regulator 2
15	VSPA	Differential output voltage positive sense for regulator 2
16	DIFFA	Output for regulator 2's differential remote sense amplifier
17	FBA	Error amplifier voltage feedback for regulator 2
18	COMPA	Output of the error amplifier and the inverting inputs of the PWM comparators of output for regulator 2
19	CSCOMPA	Output of total-current-sense amplifier for regulator 2
20	ILIMA	Over-current threshold setting – programmed with a resistor to CSCOMPA output for regulator 2
21	CSSUMA	Inverting input of total-current-sense amplifier of output for regulator 2
22	CSREFA	Total current sense amplifier reference input for regulator 2.
23	CSP1A	Non-inverting input to current-balance amplifier for Phase 1 output for regulator 2
24	CSP2A	Non-inverting input to current-balance amplifier for Phase 2 output for regulator 2. Pull this pin to Vcc to disable Phase 2
25	NC	No Connect
26	TSENSEA	Temperature sense and fault reporting input for regulator 2

# NCP81567

**Table 1. PIN FUNCTION DESCRIPTION**

Pin No.	Pin Name	Description
27	PWM1A / ICCMAXA	PWM1 output for regulator 2. During startup, ICCMAXA for two-phase regulator is programmed with a pull-down resistor
28	PWM2A	PWM2 output for regulator 2
29	DRON	External FET driver enable for discrete driver or <b>onsemi</b> DrMOS
30	PWM6 / ICCMAX_AUXIN	PWM6 output for regulator 1 / Pulldown resistor on this pin programs ICCMAX for the AUX_IN monitoring rail
31	PWM5 / ROSCA	PWM5 output for regulator 1 / Pulldown on this pin programs RoscA % dependent on main rail value and ICCMAX range for main rail
32	PWM4 / ROSC	PWM4 output for regulator 1 / Pulldown on this pin programs Rosc value for main rail
33	PWM3 / ICCMAX	PWM3 output for regulator 1 / Pulldown on this pin programs ICCMAX for regulator 1 during startup
34	PWM2 / VBOOT	PWM2 output for regulator 1 / Pin-program for regulator 1 and regulator 2 Vboot
35	PWM1 / SV_ADDR_SR	PWM1 output for regulator 1 / Pulldown on this pin configures SVID address, slew rate and Intel Proprietary Current Protection Feature
36	TSENSE	Temperature sense and fault reporting input for regulator 1
37	CSP1	Differential current sense positive for Phase 1 of regulator 1
38	CSP2	Differential current sense positive for Phase 2 of regulator 1
39	CSP3	Differential current sense positive for Phase 3 of regulator 1
40	CSP4	Differential current sense positive for Phase 4 of regulator 1
41	CSP5	Differential current sense positive for Phase 5 of regulator 1
42	CSP6	Differential current sense positive for Phase 6 of regulator 1
43	CSREF	Total current sense amplifier reference input for regulator 1.
44	CSSUM	Inverting input of total-current-sense amplifier for regulator 1
45	ILIM	Over-current threshold setting – programmed with a resistor to CSCOMP for regulator 1
46	CSCOMP	Output of total-current-sense amplifier for regulator 1
47	COMP	Output of the error amplifier and the inverting inputs of the PWM comparators for regulator 1
48	FB	Error amplifier voltage feedback for regulator 1
49	DIFF	Output of the regulator 1 differential remote sense amplifier
50	VSP	Differential output voltage sense positive for regulator 1
51	VSN	Differential output voltage sense negative for regulator 1
52	IOUT	Total output current monitor for regulator 1
-	FLAG	GND

1. 'Regulator 1' is referred to as 'Main' rail throughout the datasheet. 'Main' is the primary rail with the highest phase count.
2. 'Regulator 2' is referred to as 'A' rail throughout the datasheet.

# NCP81567

**Table 2. MAXIMUM RATINGS** (Note 3)

Pin Symbol	V <sub>MAX</sub>	V <sub>MIN</sub>	I <sub>SOURCE</sub>	I <sub>SINK</sub>
COMP	VCC + 0.3 V	-0.3 V	2 mA	2 mA
COMPA	VCC + 0.3 V	-0.3 V	2 mA	2 mA
CSCOMP	VCC + 0.3 V	-0.3 V	2 mA	2 mA
CSCOMPA	VCC + 0.3 V	-0.3 V	2 mA	2 mA
PWMX	VCC + 0.3 V	-0.3 V		1 mA
VSN	GND + 0.3 V	GND - 0.3 V	1 mA	2 mA
VSNA	GND + 0.3 V	GND - 0.3 V	1 mA	2 mA
DIFF	VCC + 0.3 V	-0.3 V	2 mA	2 mA
DIFFA	VCC + 0.3 V	-0.3 V	2 mA	2 mA
VR_RDY	VCC + 0.3 V	-0.3 V	2 mA	
VCC	6.0 V	-0.3 V		
VRMP	VCC + 0.3 V	-0.3 V		
SCLK, SDIO	3.6 V	-0.3 V		
All Other Pins	VCC + 0.3 V	-0.3 V		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

3. All signals referenced to GND unless noted otherwise

**Table 3. ESD Capability**

Description	Symbol	Typ	Unit
ESD Capability, Human Body Model (Note 4)	ESD <sub>HBM</sub>	2000	V
ESD Capability, Charged Device Model (Note 4)	ESD <sub>CDM</sub>	750	V

4. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114)

ESD Charged Device Model tested per AEC-Q100-011 (EIA/JESD22-C101)

Latch-up Current Maximum Rating: 200 mA per JEDEC standard: JESD78.

**Table 4. RECOMMENDED OPERATING CONDITIONS**

Description	Symbol	Min	Max	Unit
VCC Voltage Range	VCC	4.75	5.25	V
Operating Junction Temperature Range (Note 5)	T <sub>J</sub>	-40	125	°C
Operating Ambient Temperature Range	T <sub>A</sub>	-40	100	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

5. JEDEC JESD 51-7 with 0 LFM

**Table 5. THERMAL CHARACTERISTICS**

Description	Symbol	Typ	Unit
Thermal Characteristic QFN Package	R <sub>JA</sub>	68	°C/W
Maximum Storage Temperature Range	T <sub>STG</sub>	-40 to +150	°C
Moisture Sensitivity Level QFN Package	MSL	1	
Soldering Temperature		260	°C
Junction-to-Ambient, Thermal Resistance (Note 6)	θ <sub>JA</sub>	30	°C/W
Junction-to-Case (Top), Thermal Resistance (Note 6)	θ <sub>JC(TOP)</sub>	18	°C/W
Junction-to-Board Heat Spreader, Thermal Resistance (Note 6)	θ <sub>JB</sub>	1.0	°C/W
Junction-to-Case (Top), Measurement Reference (Note 6)	Ψ <sub>J-CT</sub>	1.1	°C/W

6. JEDEC JESD 51-7 with 0 LFM

# NCP81567

**Table 6. ELECTRICAL CHARACTERISTICS**

Unless otherwise stated:  $-40^{\circ}\text{C} < T_A < 100^{\circ}\text{C}$ ;  $4.75\text{ V} < V_{\text{CC}} < 5.25\text{ V}$ ;  $C_{\text{VCC}} = 0.1\ \mu\text{F}$

Parameter	Test Conditions	Min	Typ	Max	Unit
<b>BIAS SUPPLY</b>					
VCC Voltage Range		4.75		5.25	V
Quiescent Current	PS0		27		mA
	PS1		25		mA
	PS2		24		mA
	PS3		20		mA
	PS4			79	$\mu\text{A}$
	Enable low				64
UVLO Threshold	VCC Rising			4.5	V
	VCC Falling	4.1			V
	VCC UVLO Hysteresis		100		mV
<b>VRMP</b>					
VIN Supply Range	VRMP range prior to external voltage divider resistor network with 1/12 ratio	4.5		21	V
UVLO Threshold	VRMP Rising			0.355	V
	VRMP Falling	0.250			V
<b>ENABLE INPUT</b>					
Upper Threshold	Activation Level	0.8			V
Lower Threshold	Deactivation Level			0.3	V
<b>PHASE DETECTION</b>					
CSP Pin Threshold Voltage		VCC-0.4			V
Phase Detect Timer			1.5		ms
<b>IMVP9.2 DAC (PROTOCOL 0Eh)</b>					
System Voltage Accuracy	$0.25\text{ V} < \text{DAC} < 0.495\text{ V}$ (at $25^{\circ}\text{C}$ only)	-10		10	mV
	$0.5\text{ V} < \text{DAC} < 0.745\text{ V}$ (at $25^{\circ}\text{C}$ only)	-8		8	mV
	$0.75\text{ V} < \text{DAC} < 1.52\text{ V}$ (at $25^{\circ}\text{C}$ only)	-0.5		0.5	%
<b>DAC SLEW RATE</b>					
Soft Start Slew Rate			1/2 fast		mV/ $\mu\text{s}$
Slew Rate Slow			1/2 fast		mV/ $\mu\text{s}$
Slew Rate Fast	Resistor Selectable (Table 9)		> 10		mV/ $\mu\text{s}$
<b>DRON</b>					
Output High Voltage	Sourcing 1 mA	3			V
Output Low Voltage	Sinking 1 mA			0.1	V
<b>TSENSE</b>					
TSENSE Bias Current		115.5	120	124.5	$\mu\text{A}$
Alert#	Assert Threshold		556		mV
	De-Assert Threshold		595		mV
VR_HOT	Assert Threshold		517		mV
	De-Assert Threshold		556		mV

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

N\* is the phase configuration number in PS0.

# NCP81567

**Table 6. ELECTRICAL CHARACTERISTICS**

Unless otherwise stated:  $-40^{\circ}\text{C} < T_A < 100^{\circ}\text{C}$ ;  $4.75\text{ V} < V_{CC} < 5.25\text{ V}$ ;  $C_{VCC} = 0.1\ \mu\text{F}$

Parameter	Test Conditions	Min	Typ	Max	Unit
<b>VR_RDY OUTPUT</b>					
Output Low Saturation Voltage	$I_{VR\_RDY} = -4\text{ mA}$		0.1	0.3	V
VR_RDY Rise Time	1 k $\Omega$ pull-up to 3.3 V, $C_{TOT} = 45\text{ pF}$		110	150	ns
VR_RDY Fall Time			20	150	ns
<b>ALERT#</b>					
VOL (Output Low)				0.3	V
<b>OVP AND UVP</b>					
Absolute Over Voltage Threshold	10 mV DAC step During Soft Start – CSREF Rising	3.3	3.44	3.6	V
	5 mV DAC step During Soft Start – CSREF Rising	2.8	2.9	3.05	V
Over Voltage Threshold Above DAC	VSP–VSN–VID Rising	350	400	475	mV
Over Voltage Delay	VSP–VSN Rising to PWM Low		50		ns
Under Voltage Threshold Below DAC–DROOP (VUVM)	VSP–VSN–VID Falling	–440	–400	–360	mV
Under Voltage Delay			5		$\mu\text{s}$
<b>PWM OUTPUT</b>					
Output High Voltage	Sourcing 500 $\mu\text{A}$	$V_{CC}-0.2$			V
Output Mid Voltage	No Load, Power State 2	1.7	1.8	1.9	V
Output Low Voltage	Sinking 500 $\mu\text{A}$			0.7	V
<b>DIFFERENTIAL AMPLIFIER</b>					
Input Bias Current	VSP = 1.3 V	300		600	nA
–3 dB Bandwidth	CL = 20 pF, RL = 10 k $\Omega$		22.5		MHz
Closed Loop DC Gain	VSP – VSN = 0.5 V to 1.3 V		1		V/V
<b>ERROR AMPLIFIER</b>					
Input Bias Current	Input = 1.3 V	–400		400	nA
DC Gain	CL = 20 pF, RL = 10 k $\Omega$		80		dB
–3 dB Bandwidth	CL = 20 pF, RL = 10 k $\Omega$		20		MHz
Slew Rate	$\Delta V_{in} = 100\text{ mV}$ , $G = -10\text{ V/V}$ , $\Delta V_{out} = 1.5\text{ V to }2.5\text{ V}$ , CL = 20 pf, RL = 10 k $\Omega$		5		V/ $\mu\text{s}$
<b>OVER-CURRENT PROTECTION (ILIM)</b>					
ILim Threshold Current (Delayed OCP shutdown)	PS0	8.5	10	11.5	$\mu\text{A}$
	PS1, PS2, PS3		10/N*		$\mu\text{A}$
ILim Threshold Current (Immediate OCP shutdown)	PS0	13.5	15	16.5	$\mu\text{A}$
	PS1, PS2, PS3		15/N*		$\mu\text{A}$
Shutdown Delay	Immediate		1.3		$\mu\text{s}$
	Delayed		50		$\mu\text{s}$
<b>IOUT OUTPUT</b>					
Current Gain	IOUT/ILIM (RLIM = 20 k $\Omega$ , RIOUT = 5 k $\Omega$ , Vout = 0.8 V, 1.25 V, 1.52 V)	9.5	10	10.5	A/A

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

N\* is the phase configuration number in PS0.



# NCP81567

**Table 6. ELECTRICAL CHARACTERISTICS**

Unless otherwise stated:  $-40^{\circ}\text{C} < T_A < 100^{\circ}\text{C}$ ;  $4.75\text{ V} < V_{CC} < 5.25\text{ V}$ ;  $C_{VCC} = 0.1\ \mu\text{F}$

Parameter	Test Conditions	Min	Typ	Max	Unit
<b>PWM GENERATOR</b>					
PWM Minimum Pulse Width			40		ns
0% Duty Cycle	Comp Voltage for PWM Held Low		1.3		V
100% Duty Cycle	Comp Voltage for PWM Held High VIN at 4.5 V		1.75		V
100% Duty Cycle	Comp Voltage for PWM Held High VIN at 21 V		3.4		V
<b>CURRENT SUMMING AMPLIFIER (CSAMP)</b>					
Offset Voltage		-500		500	$\mu\text{V}$
Input Bias Current	CSSUM = CSREF = 1.0 V	-10		10	$\mu\text{A}$
Open Loop Gain			80		dB
Open Loop Unity Gain Bandwidth	$C_L = 20\ \text{pF}$ to GND, $R_L = 10\ \text{k}\Omega$ to GND		10		MHz
<b>CURRENT BALANCE AMPLIFIER</b>					
Differential Mode Input Voltage Range	CSNx = 1.2 V	-100		100	mV
<b>PSYS</b>					
Full Scale Input Voltage			2.5		V
Disable Threshold			VCC-0.4		V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

N\* is the phase configuration number in PS0.

**Start Up**

Following the rise of VCC above the UVLO threshold, externally programmed configuration data is collected, and all PWM outputs are set to Mid-level to prepare the gate drivers of the power stages for activation. When the controller is enabled, DRON is asserted (high) to activate the external gate drivers. A digital counter steps the DAC up from zero to the target boot voltage based on the Soft Start

Slew Rate in the spec table. As the DAC ramps, the PWM outputs of each rail will change from Mid-level to high when the first PWM pulse for that rail is produced. When the controller is disabled, the PWM signals return to Mid-level. The VR\_RDY signal is asserted when the controller is ready to accept the first SVID command.

**DEVICE CONFIGURATION**

**Phase and Rail Configuration**

During start-up, the number of operational phases of the multiphase rail is determined by the internal circuitry monitoring the CSP inputs. If a reduced phase count is required, the appropriate CSP pins should be externally pulled to VCC with a resistor during startup. When used with the NCP81568 controller, the PSYS input needs to be connected to VCC so that it does not respond to any calls on the SVID bus. PSYS functionality is enabled on the NCP81568 only.

**Basic Configuration**

The controller has four basic configuration features. On power up a 10 μA current is sourced from these pins through a resistor connected to this pin and the resulting voltage is measured. The following features will be programmed:

- SVID Address
- Slew Rate
- V<sub>BOOT</sub>
- Output Voltage Step

**Intel Proprietary Current Protection Feature**

VR\_HOT assertion for Intel Proprietary Current Protection Feature on/off selection as shown in Table 9.

**Switching Frequency**

Switching frequencies between 180 kHz and 1.17 MHz are programmed on power up with pulldown resistors on Rosc and RoscA pin. Switching frequency options are shown in Table 12.

**ICCMAX**

The SVID interface provides the platform ICCMAX values at register 21h. Resistors to ground on the

PWM3/ICCMAX, PWM1A/ICCMAXA and PWM6/ICCMAX\_AUXIN pins programs these registers on power up. 10 μA is sourced from this pin to generate a voltage on the program resistor. The value of the register is set by the equation below. The resistor value should be no less than 10 kΩ.

$$ICCMAX_{21h} = \frac{R \cdot 10 \mu A \cdot 255}{2.5 V}$$

**ICCMAX Additional Capability**

IMVP9.2 adds an option to extend the current range of the main rail by scaling the lsb size of register ICCMAX<sub>21h</sub> by 2<sup>ICCMAX\_ADD50h[1:0]</sup> amps (See Table 7). On the NCP81567, these register bits can be configured to 2 A per bit by enabling ICC\*2\_MAIN\_RAIL mode. See Table 11 for details on how to enable this mode.

**Table 7. ICCMAX CAPABILITY SCALING**

ICCMAX_ADD50h[4:0]		ICC Scaling	Power Scaling
Power [4:2]	Current [1:0]		
010	00	1 A / bit	4 W / bit
011	01	2 A / bit	8 W / bit

When ICC\*2\_MAIN\_RAIL mode is enabled, the bits ICCMAX\_ADD50h[1:0] are set to 01b to indicate a scaling of 2 A per bit. This scaling applies to both the ICCMAX<sub>21h</sub> and the IOUT\_H15h SVID registers. The bits ICCMAX\_ADD50h[4:2] are also set to 011b to indicate that the POUT\_H18h register value is scaled to 8 W per bit. Table 8 shows the rail configurations when ICC\*2\_MAIN\_RAIL mode is enabled and disabled.

Table 8. RAIL SETTINGS FOR ICC\*2\_MAIN\_RAIL MODE

		ICC*2_MAIN_RAIL	
		Disabled	Enabled
Main Rail	ICCMAX <sub>21h</sub> LSB Size	1A	2A
	IOUT <sub>15h</sub> LSB Size	1A	2A
	POUT <sub>18h</sub> LSB Size	4 W	8 W
	HIGHPOWER_ICCMAX_ADD <sub>50h</sub> [1:0]	00	01
	HIGHPOWER_ICCMAX_ADD <sub>50h</sub> [4:2]	010	011
	Loadline Weighting	93.75%	187.5%
A Rail	ICCMAX <sub>21h</sub> LSB Size	1A	
	IOUT <sub>15h</sub> LSB Size	1A	
	POUT <sub>18h</sub> LSB Size	4 W	
	HIGHPOWER_ICCMAX_ADD <sub>50h</sub> [1:0]	00	
	HIGHPOWER_ICCMAX_ADD <sub>50h</sub> [4:2]	010	
	Loadline Weighting	93.75%	
VCCIN_AUX	ICCMAX <sub>21h</sub> LSB Size	1A	
	IOUT <sub>15h</sub> LSB Size	1A	
	POUT <sub>18h</sub> LSB Size	4 W	
	HIGHPOWER_ICCMAX_ADD <sub>50h</sub> [1:0]	00	
	HIGHPOWER_ICCMAX_ADD <sub>50h</sub> [4:2]	010	

**Ultrasonic Mode**

The switching frequency of a rail in DCM will decrease at very light loads. Ultrasonic Mode forces the switching frequency to stay above the audible range.

**CCM/DCM Operation**

In PS0, all rails operate in Continuous Conduction Mode (CCM) which uses the dual-edge control methodology. However, if PS0 is configured as one-phase instead of multi-phase, the control methodology changes to RPM operation. RPM has great transient performance in one-phase CCM operation. The RPM frequency average DC value is targeted to be similar to the PS0 Dual Edge frequency. However, the switching frequency of RPM depends on input voltage, output voltage, load current, inductor value, and output capacitor value. In PS1, all rails operate in one-phase CCM RPM. In PS2 and PS3, all rails operate in either CCM or Discontinuous Conduction Mode (DCM). It depends on load current in order to prevent loss of efficiency from negative inductor current.

Table 9. SVID ADDRESS, SLEW RATE AND FAST V MODE

Resistor (kΩ)	SR (mV/μs)	Main Rail SVID Address	A Rail SVID Address	Intel Proprietary Current Protection Feature
10	10	0	1	ON
14	30	0	1	ON
18.7	48	0	1	ON
24.3	10	0	1	OFF
30.9	30	0	1	OFF
38.3	48	0	1	OFF
47.5	10	0	2	ON
59	30	0	2	ON
71.5	48	0	2	ON
86.6	10	0	2	OFF
105	30	0	2	OFF
127	48	0	2	OFF

**Table 10. V<sub>BOOT</sub> AND OUTPUT VOLTAGE STEP**

Resistor (kΩ)	V <sub>BOOT</sub> (V) Main Rail	V <sub>BOOT</sub> (V) A Rail	Output Voltage Step
10	0 V	0 V	Both rail 5 mV/step
14	0 V	1.05 V	
18.7	1.05 V	0 V	
24.3	1.05 V	1.05 V	
30.9	0 V	0 V	Both rail 10 mV/step
38.3	0 V	1.8 V	
47.5	1.8 V	0 V	
59	1.8 V	1.8 V	
71.5	0 V	0 V	Main rail 5 mV/step. A rail 10 mV/step.
86.6	0 V	1.8 V	
105	1.05 V	0 V	
127	1.05 V	1.8 V	
154	0 V	0 V	Main rail 10 mV/step. A rail 5 mV/step.
187	1.8 V	0 V	
221	0 V	1.05 V	
280	1.8 V	1.05 V	

**PSYS**

The PSYS pin is an analog input to the VR controller. PSYS is a system input power monitor that facilitates the

monitoring of the total platform system power. For more information regarding PSYS please contact Intel, inc.

**AUX\_IN**

The AUX\_IMON current monitor input is a means of measuring the VCCIN\_AUX platform VR output current using the IMVP9.2 ADC.

**Programming Pin**

This is a multifunction select pin used to set the operation of multiple features and the combination of these features enabled/disable. Items programmed on this pin are ICC\*2\_MAIN\_RAIL which allows the user to select if the ICCMAX and IOOUT reporting for the main rail is a 1 A or 2 A LSB step size. When off, the resolution is 1 A per LSB. When on, the resolution is set to 2 A per LSB which allows reporting of over 255 A on the main rail only.

Automatic Power Management is used to add or remove phases based on real time load current requirements sensed by the controller. The phase configuration levels are defined as:

- <5A = DCM
- <15A = CCM 1-phase
- <25A = CCM 2-phase
- >25A = CCM All phases on

The other options include dithering and acoustic noise solution.

# NCP81567

Table 11. PIN OF ICC\*2\_MAIN\_RAIL CONFIGURATION

Resistor (k $\Omega$ )	ICCMAX*2 Main Rail	Acoustic Noise Solution	Spread Spectrum	Automatic Power Management
10	OFF	OFF	OFF	OFF
14	OFF	OFF	OFF	ON
18.7	OFF	OFF	ON	OFF
24.3	OFF	OFF	ON	ON
30.9	OFF	ON	OFF	OFF
38.3	OFF	ON	OFF	ON
47.5	OFF	ON	ON	OFF
59	OFF	ON	ON	ON
71.5	ON	OFF	OFF	OFF
86.6	ON	OFF	OFF	ON
105	ON	OFF	ON	OFF
127	ON	OFF	ON	ON
154	ON	ON	OFF	OFF
187	ON	ON	OFF	ON
221	ON	ON	ON	OFF
280	ON	ON	ON	ON

Table 12. SWITCHING FREQUENCY

Rosc/Rosca Control by Pin Resistor (kΩ)	Switching Frequency (KHz)
	1 Phase ~ 6 Phase
10	180
14	225
18.7	270
24.3	315
30.9	360
38.3	405
47.5	450
59	495
71.5	540
86.6	630
105	720
127	810
154	900
187	990
221	1080
280	1170

**Input Voltage Feed-Forward (VRMP Pin)**

Ramp generator circuits are provided for the dual-edge modulator. The ramp generators implement input voltage feed-forward control by varying the ramp slopes proportional to the VRMP pin voltage. The VRMP pin also has a UVLO function, which is active only after the controller is enabled. The VRMP pin is high impedance input when the controller is disabled. For multi-phase operation, the dual-edge PWM ramp amplitude is changed according to the following:

$$VRMP_{PP} = 0.1 \cdot V_{VRMP}$$

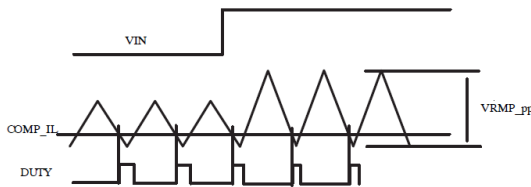


Figure 4. Ramp Feed Forward

An external voltage divider is required on this VRMP pin. In order to scale the voltage seen on the VRMP pin, the voltage divider on the pin needs to be setup to maintain a ratio of 1/12. Typical resistor values may include 1 MΩ Rup / 90.9 kΩ Rdown or 1.1 MΩ Rup / 100 kΩ Rdown. UVLO on VRMP is inactive in PS4 power state and PS3 when a VID to 0 V is received.

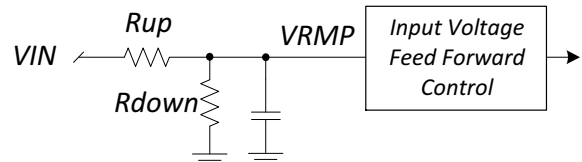


Figure 5. Ramp Feed Forward Circuit

**Differential Current Feedback Amplifiers**

Each phase of the rail has a low offset, differential amplifier to sense the current of that phase in order to balance current. The CSREF and CSPx pins are high impedance inputs, but it is recommended that any external filter resistor RCSN does not exceed 10 kΩ to avoid offset due to leakage current.

It is also recommended that the voltage sense element be no less than 0.5 mΩ for best current balance.

The external filter RCSN and CCSN time constant should match the inductor L/DCR time constant, but fine tuning of this time constant is generally not required. Phase current signals are summed with the COMP or ramp signals at their respective PWM comparator inputs in order to balance phase currents via a current mode control approach.

$$R_{CSN} = \frac{L_{PHASE}}{C_{CSN} \cdot DCR}$$

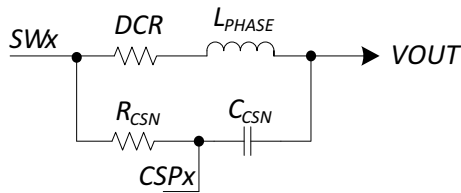


Figure 6. Per Phase Current Sense Network

**Total Current Sense Amplifier**

The multiphase rail uses a patented approach to sum the phase currents into a single, temperature compensated, total current signal. This signal is then used to generate the output voltage droop, total current limit, and the output current monitoring functions. The Rref(n) resistors average the voltages at the output terminals of the inductors to create a low impedance reference voltage at CSREF. The Rph resistors sum currents from the switch nodes to the virtual CSREF potential created at the CSSUM pin by the amplifier. The total current signal is the difference between the CSCOMP and CSREF voltages.

The amplifier filters, and amplifies, the voltage across the inductors in order to extract only the voltage across the inductor series resistances (DCR). An NTC thermistor (Rth) in the feedback network placed near the Phase 1 inductor senses the inductor temperature, and compensates both the DC gain and the filter time constant for the change in DCR with temperature. The Phase 1 inductor is chosen for the thermistor location so that the temperature of the inductor providing current in the PS1 power mode.

The DC gain equation for the DC total current signal is:

$$V_{CSCOMP} - V_{CSREF} = \frac{R_{CS2} + \frac{R_{CS1} \cdot R_{th}}{R_{CS1} + R_{th}}}{R_{ph}} \cdot DCR \cdot I_{OUT}$$

Set the DC gain by adjusting the value of the Rph resistors in order to make the ratio of total current signal to output current equal the desired loadline. The values of Rcs1 and Rcs2 are set based on the effect of temperature on both the thermistor and inductor, and may need to be adjusted to eliminate output voltage temperature drift with the final product enclosure and cooling.

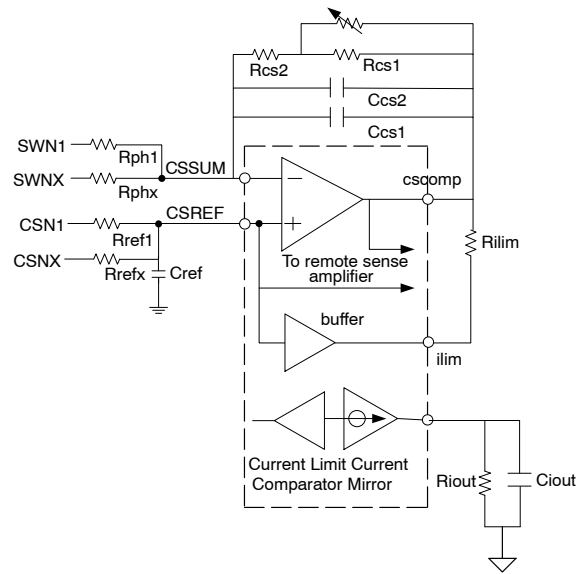


Figure 7. Total Current Sense Amplifier

The pole frequency of the CSCOMP filter should be set equal to the zero of the output inductor. This causes the total current signal to contain only the component of inductor voltage caused by the DCR voltage, and therefore to be proportional to inductor current. Connecting Ccs2 in parallel with Ccs1 allows fine tuning of the pole frequency using commonly available capacitor values. It is best to perform fine tuning during transient testing.

$$F_z = \frac{DCR_{25^\circ C}}{2\pi \cdot L_{PHASE}}$$

$$F_p = \frac{1}{2\pi \cdot \left( R_{CS2} + \frac{R_{CS1} \cdot R_{th}}{R_{CS1} + R_{th}} \right) \cdot (C_{CS1} + C_{CS2})}$$

This signal then goes through a standard error compensation network and into the inverting input of the error amplifier.

The value of the CREF capacitor (in nF) on the CSREF pin should be:

$$C_{ref} = \frac{0.02 \cdot R_{ph}}{R_{ref}}$$

**High Performance Voltage Error Amplifier**

The Remote Sense Amplifier output feeds a Type III compensation network formed by the Error Amplifier and external tuning components. The non-inverting input of the error amplifier is connected to the same reference voltage used to bias the Remote Sense Amplifier output.

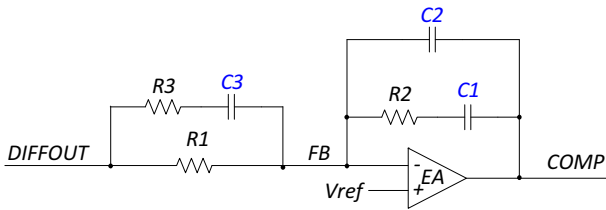


Figure 8. Error Amplifier

**Loadline Programming (V<sub>DROOP</sub>)**

An output loadline is a power supply characteristic wherein the regulated (DC) output voltage decreases proportional to load current. This characteristic can reduce the output capacitance required to maintain output voltage within limits during load transients faster than those to which the regulation loop can respond.

A load line is produced by adding a signal proportional to output load current (V<sub>DROOP</sub>) to the output voltage feedback signal – thereby satisfying the voltage regulator at an output voltage reduced proportional to load current. The load line is programmed by setting the gain of the Total Current Sense Amplifier such that the total current signal is equal to the desired output voltage droop.

$$V_{DROOP} = \frac{R_{CS2} + \frac{R_{CS1} \cdot R_{th}}{R_{ph}}}{R_{ph}} \cdot DCR \cdot I_{OUT}$$

For the main rail, loadline programming is dependent on its programmed ICCMAX value.

$$\text{Loadline} = DCR \times \frac{R_{cs}}{R_{ph}} \times \text{Weighting}$$

For ICC\*2\_MAIN\_RAIL configuration enabled, weighting = 187.50%.

For ICC\*2\_MAIN\_RAIL configuration disabled, weighting = 93.75%.

For the A rail, loadline weighting = 93.75%

**Rail Remote Sense Amplifier**

A high performance high input impedance true differential amplifier is provided to accurately sense regulator output voltage. The VSP and VSN inputs should be connected to the regulator’s output voltage sense points. The remote sense amplifier takes the difference of the output voltage with the DAC voltage and adds the droop voltage.

$$V_{DIFFOUT} = (V_{VSP} - V_{VSN}) + (1.3 \text{ V} - V_{DAC}) + (V_{DROOP} - V_{CSREF})$$

**Programming the Current Limit**

The current limit thresholds are programmed with a resistor between the ILIM and CSCOMP pins. The multiphase rails generates a replica of the CSREF pin voltage at the ILIM pin, and compares ILIM pin current to

ICL0 and ICLM0 (ICL1 and ICLM1 in PS1, PS2 and PS3). The controller latches off if ILIM pin current exceeds ICL0 (ICL1 for PS1, PS2, and PS3) for t<sub>OC<sub>P</sub> DELAY</sub>, and latches off immediately if ILIM pin current exceeds ICLM0 (ICLM1 for PS1, PS2 and PS3). Set the value of the current limit resistor RLIMIT according to the desired current limit I<sub>out</sub> LIMIT.

$$R_{LIMIT} = \frac{R_{CS2} + \frac{R_{CS1} \cdot R_{th}}{R_{ph}}}{10 \mu} \cdot DCR \cdot I_{OUT\_LIM}$$

**Programming IOU<sub>T</sub>**

The IOU<sub>T</sub> pin sources a current proportional to the ILIM current. The voltage on the IOU<sub>T</sub> pin is monitored by the internal A/D converter and should be scaled with an external resistor to ground such that a load equal to ICCMAX generates a 2.5 V signal on IOU<sub>T</sub>.

$$R_{IOU_T} = \frac{2.5 \text{ V} \cdot R_{LIM}}{10 \cdot \frac{R_{CS2} + \frac{R_{CS1} \cdot R_{th}}{R_{ph}}}{R_{ph}} \cdot DCR \cdot ICCMAX}$$

**Programming DAC Feed-Forward Filter**

The multiphase rail outputs a pulse of current from the VSN pin upon each increment of the internal DAC following a DVID UP command. A parallel RC network inserted into the path from VSN to the output voltage return sense point, VSS\_SENSE, causes these current pulses to temporarily decrease the voltage between VSP and VSN. This causes the output voltage during DVID to be regulated slightly higher, in order to compensate for the response of the DROOP function to current flowing into the charging output capacitors. In the following equations, C<sub>OUT</sub> is the total output capacitance of the system.

$$R_{FF} = C_{out} \cdot LL \cdot 453.6 \cdot 10^6$$

$$C_{FF} = \frac{LL \cdot C_{out}}{R_{FF}}$$

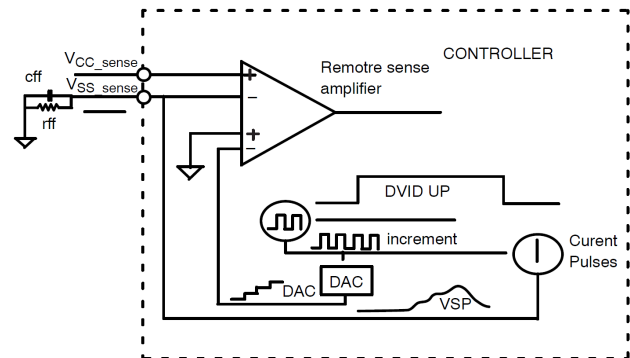
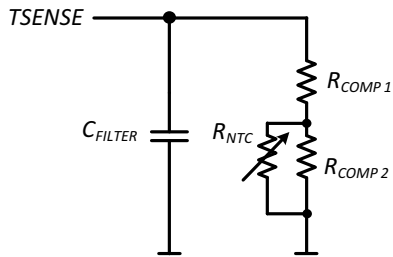


Figure 9. DAC Feed Forward



**TSENSE Network**

A temperature sense input is provided for each rail. A precision current is sourced from the output of the TSENSE/A pins to generate a voltage on the temperature sense networks. The voltages on the temperature sense inputs are sampled by the internal A/D converter. A 100 k NTC similar to the Murata NCP15WF104E03RC should be used. Rcomp1 in the following Figure is optional, and can be used to slightly change the hysteresis. See the specification table for the thermal sensing voltage thresholds and source current.



**Figure 10. TSENSE Network**

**PWM Comparators**

The noninverting input of each comparator (one for each phase) is connected to the summation of the error amplifier output (COMP) and each phase current ( $I_L \times DCR \times \text{Phase Balance Gain Factor}$ ). The inverting input is connected to the triangle ramp voltage of that phase. The output of the comparator generates the PWM output. During steady state PS0 operation, the main rail PWM pulses are centered on the valley of the triangle ramp waveforms and both edges of the PWM signals are modulated. During a transient event, the duty cycle can increase rapidly as the error amp signal increases with respect to the ramps, to provide a highly linear and proportional response to the step load.

Table 13. PHASE CONFIGURATION

Phase Configuration	Programming Pin in CSPx	Unused Pin
6+2	All CSP pins are connected normally	No unused Pin
5+2	CSP1 to CSP5, CSP1A and CSP2A pins connected normally. CSP6 connected to VCC through a 2k resistor.	Float PWM6.
4+2	CSP1 to CSP4, CSP1A and CSP2A pins connected normally. CSP5 connected to VCC through a 2k resistor.	Float PWM6 and CSP6. Use PWM5 for programming ROSCA only.
3+2	CSP1 to CSP3, CSP1A and CSP2A pins connected normally. CSP4 connected to VCC through a 2k resistor.	Float PWM6, CSP5 and CSP6. Use PWM5 for programming ROSCA only. Use PWM4 for programming ROSC only.
2+2	CSP1, CSP2, CSP1A and CSP2A pins connected normally. CSP3 connected to VCC through a 2k resistor.	Float PWM6, CSP4, CSP5 and CSP6. Use PWM5 for programming ROSCA only. Use PWM4 for programming ROSC only. Use PWM3 for programming ICCMAX only.
2+1	CSP1, CSP2, CSP1A pins connected normally. CSP3 and CSP2A connected to VCC through a 2k resistor.	Float PWM6, PWM2A, CSP4, CSP5 and CSP6. Use PWM5 for programming ROSCA only. Use PWM4 for programming ROSC only. Use PWM3 for programming ICCMAX only.
2+0	CSP1, CSP2, pins connected normally. CSP3 and CSP1A connected to VCC through a 2k resistor.	Float PWM6, PWM1A, PWM2A, CSP4, CSP5, CSP6 and CSP2A. Use PWM5 for programming ROSCA only. Use PWM4 for programming ROSC only. Use PWM3 for programming ICCMAX only.
1+1	CSP1 and CSP1A pins connected normally. CSP2 and CSP2A connected to VCC through a 2k resistor.	Float PWM6, PWM2A, CSP3, CSP4, CSP5, CSP6. Use PWM5 for programming ROSCA only. Use PWM4 for programming ROSC only. Use PWM3 for programming ICCMAX only. Use PWM2 for programming VBOOT only.
1+0	CSP1 pin connected normally. CSP2 and CSP1A connected to VCC through a 2k resistor.	Float PWM6, PWM1A, PWM2A, CSP3, CSP4, CSP5, CSP6 and CSP2A. Use PWM5 for programming ROSCA only. Use PWM4 for programming ROSC only. Use PWM3 for programming ICCMAX only. Use PWM2 for programming VBOOT only.

**FAULT PROTECTION**

**Over Current Protection (OCP)**

A programmable total phase current limit is provided that is decreased when not operating in PS0 mode. This limit is programmed with a resistor between the CSCOMP and ILIM pins. The current from the ILIM pin to this resistor is compared to the ILIM Threshold Currents (ICL0, ICLM0, ICL1, and ICLM1). When the A rail is operating in PS0, if the ILIM pin current exceeds ICL0, an internal latch-off timer starts.

If the fault is not removed, the controller shuts down when the timer expires. If the current into the pin exceeds ICLM0, the controller shuts down immediately. When operating in PS1, PS2, or PS3, the ILIM pin current limits are ICL1 and ICLM1. To recover from an OCP fault, the EN pin or VCC voltage must be cycled low.

**Input Under-voltage Lockouts (UVLO)**

The VR monitors the 5 V VCC supply as well as the VRMP pin voltage. Hysteresis is incorporated within these monitors.

**Output Under Voltage Monitor**

The multiphase rail output voltage is monitored for under voltage at the output of the differential amplifier. If the

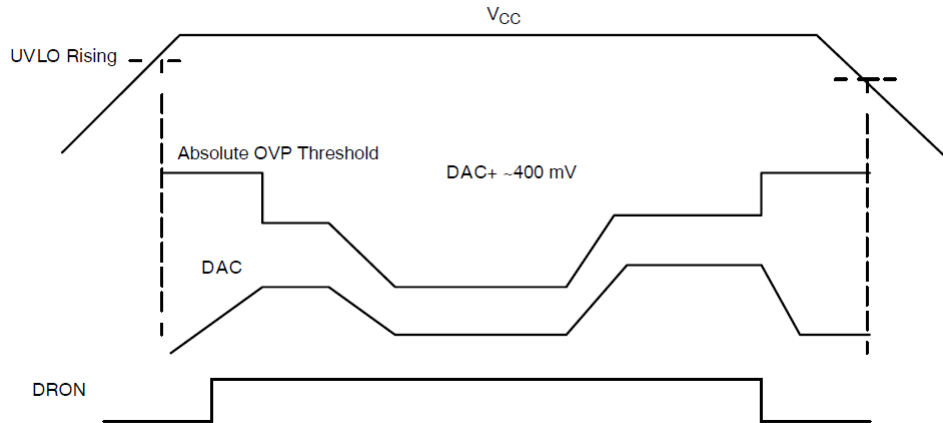
multiphase-phase rail output falls more than VUVM2 below the DAC-DROOP voltage, the UVM comparator will trip – sending the VR\_RDY signal low.

**Output Over Voltage Protection**

The multiphase phase output voltage is monitored for OVP at the VSP pin. During normal operation, if an output voltage exceeds the DAC voltage by VOVP, the VR\_RDY flag goes low, and the DAC voltage of the overvoltage rail will be slowly ramped down to 0 V to avoid producing a negative output voltage. At the same time, the PWM outputs of the overvoltage rail are sent low. The PWM output will pulse to mid-level during the DAC ramp down period if the output decreases below the DAC + OVP threshold as DAC decreases. When the DAC gets to zero, the PWMs will be held low, and the VR will stay in this mode until the VCC voltage or EN is toggled.

**Absolute OVP**

During start up, the OVP threshold is set to the absolute over voltage threshold. This allows the controller to start up without false triggering OVP.



**Figure 11. OVP Threshold Behavior**

# NCP81567

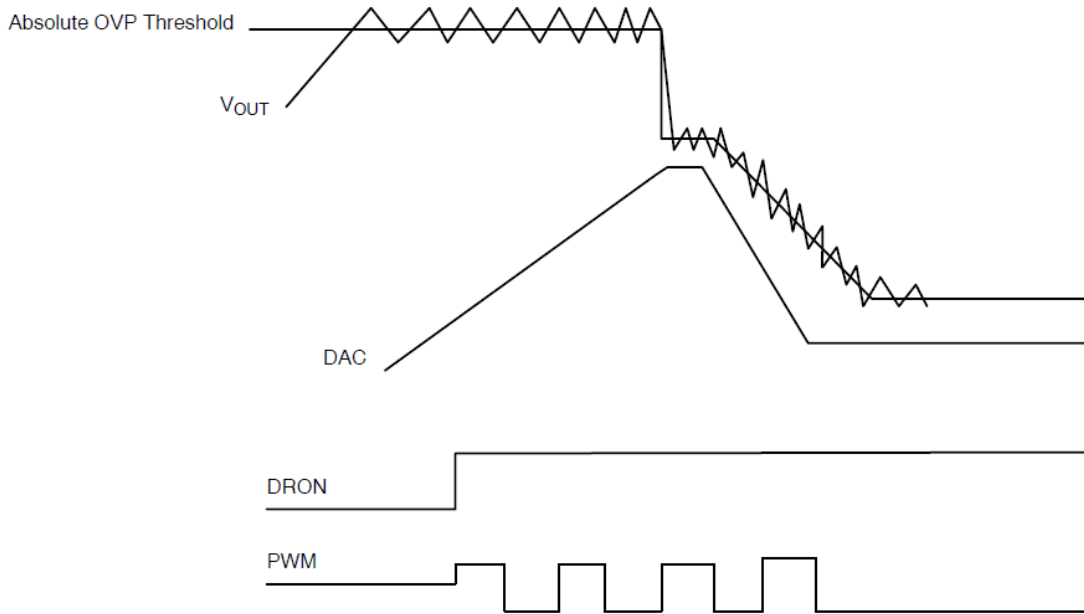


Figure 12. OVP Behavior at Start-up

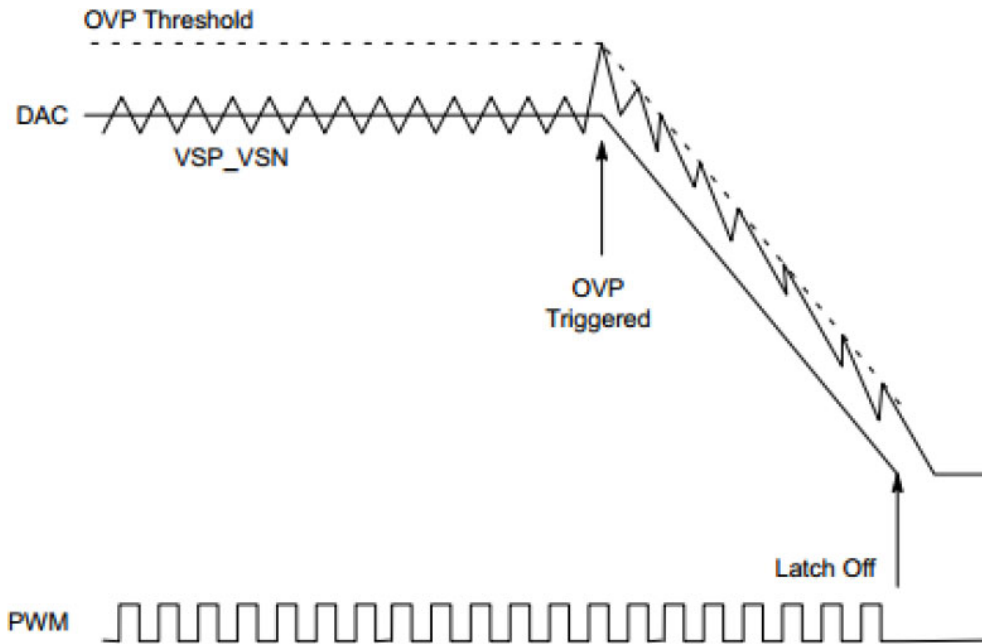


Figure 13. OVP During Normal Operation Mode

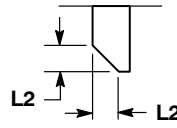
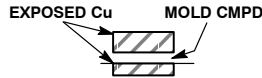
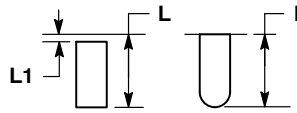
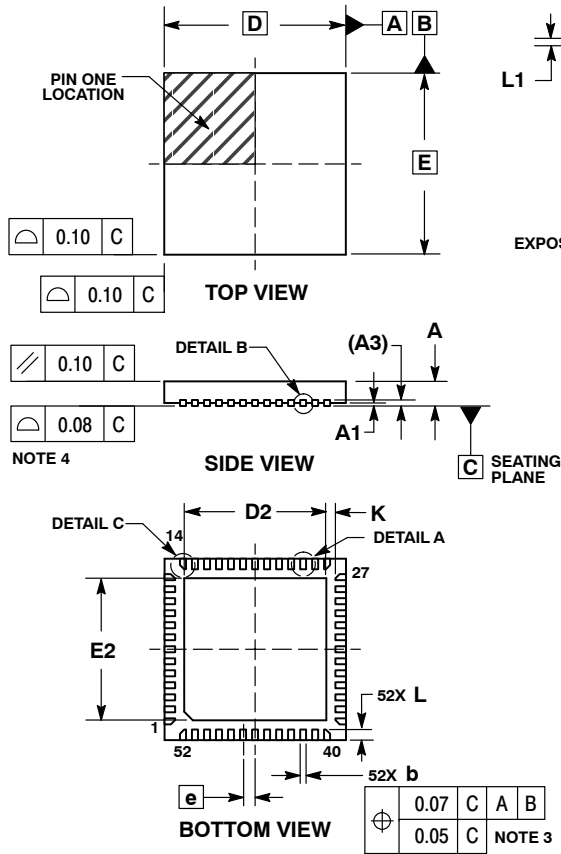
## Serial VID Interface (SVID)

For Intel proprietary interface communication details please contact Intel, inc.

# NCP81567

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QFN52 6x6, 0.4P  
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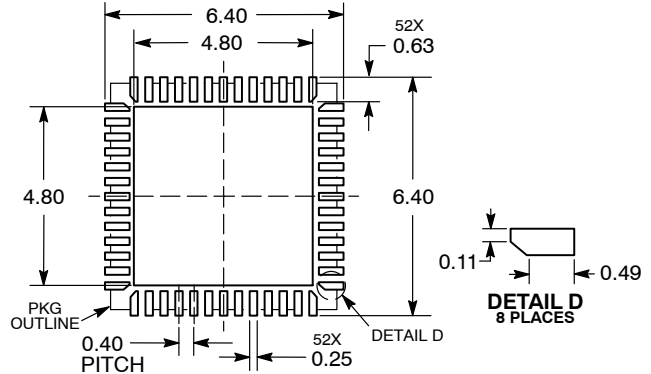


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSIONS: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM TERMINAL TIP
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.80	1.00
A1	0.00	0.05
A3	0.20	REF
b	0.15	0.25
D	6.00	BSC
D2	4.60	4.80
E	6.00	BSC
E2	4.60	4.80
e	0.40	BSC
K	0.30	REF
L	0.25	0.45
L1	0.00	0.15
L2	0.15	REF

**SOLDERING FOOTPRINT\***



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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